

Title (en)

ELECTRODE APPLICATORS FOR CONJUNCTIVE USE IN A DENTAL IMPLANT TREATMENT SYSTEM

Title (de)

ELEKTRODENAPPLIKATOREN ZUR VERWENDUNG IN EINEM ZAHNIMPLANTATBEHANDLUNGSSYSTEM

Title (fr)

APPLICATEURS D'ÉLECTRODE DESTINÉS À ÊTRE UTILISÉS CONJOINTEMENT DANS UN SYSTÈME DE TRAITEMENT D'IMPLANT DENTAIRE

Publication

EP 4114304 A4 20230802 (EN)

Application

EP 20923389 A 20200707

Priority

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Abstract (en)

[origin: WO2021177995A1] An apparatus for use with a treatment system to disrupt bacteria from a metallic dental implant includes apparatus configured for mechanical and electrical connection to a device capable of producing an electrical stimulation voltage, and in which a connective body is further configured for attachment to the mouth of a patient and including at least one metal contact. The apparatus can include a mouth guard having at least one integrated or releasably attachable metal contact. Alternatively, at least one clip member can be attached, the clip member having a metal contact portion. The apparatus can be used in conjunction with any electrode of a treatment system in which the electrode is disposed within the mouth of the patient or external.

IPC 8 full level

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CPC (source: EP)

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Citation (search report)

- [A] US 2016000947 A1 20160107 - BRODBECK URS [CH]
- [A] US 2019328913 A1 20191031 - SCHLEE MARKUS [DE]
- See also references of WO 2021177995A1

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